The Filling Process of Molding Ultra-Thin Parts with Multi-Cavities

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Introduction

- The definition of thin part (Losch1997) :
- The thickness of molding parts is less than
 1.5mm
- 2. The ratio of flow length to cavity thickness is more than 100 : 1

In this study the thickness of molding parts is $100\mu m$ and $250\mu m$, and flow length is 5mm

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The Demends of Molding Ultra-Thin Parts

Due to the extremely high flow resistance and fast heat transfer, ultra-thin parts is difficult to mold.

Results:

- 1. High Injection Rate
 - short heat transfer time
 - high shear-thinning
 - high shear-heating
- 2. High Mold Temperature
 - decrease heat flux between the boundary of mold and melt



The Illustration of Molded Parts

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Cavities: 5mm x 5mm square with thickness of 100µm and 250µm



Runner: cavity thickness + 0.6mm



Mold Design



Injection Machine

FANUC a-15iA

Clamping Force:15 tonf Screw Diameter : 16 mm Max. Injection speed : 200 mm/s Max. Injection Pressure : 220 MPa





Cavities Filling Process

The melt fronts are observed with short-shot samples



Cavity thickness 250µm Runner thickness 850µm Injection Speed=80mm/sec Mold Temp.=80°C

Cavity thickness 100µm Runner thickness 700µm Injection Speed=80mm/sec Mold Temp.=80°C



Simulation

Moldex 3D (Taiwain)

Cavity thickness 100μm , Runner thickness 700μm)

■ Speed=80mm/sec,Tmold=80°C





Experiment: Short-Shot Samples

Simulation: Melt Front

The Simulation Results of Cavities Pressure Variation During Filling Process





The pressure rise in the entrance of near-end cavities between 0.026 and 0.027 seconds is slow since the flow resistance to enter the cavity of 100µm thick is much larger than that to flow in runner leading to the far-end cavities.

The Simulation Results of Melt Temperature During Filling Process



- 1. During the short interval of 0.1 ms (0.026 to 0.027 seconds), the melt temperature in near-end cavity is cooled down from 206°C to 189 °C.
- 2. The decrease of melt temperature and flow speed causes the increase of melt viscosity which will result in the lag of the melt-front advancement.



The Simulation Results of Melt Front Temperature During Filling Process



The far-end cavities are filled under higher temperature than the near-end cavities



250µm Cavities Filling Process under Various Operating Parameters

The melt fronts are observed with short-shot samples (Cavity thickness 250µm, Runner thickness 850µm)



Speed=80mm/sec,T_{mold}=140°C



Speed=80mm/sec, T_{mold}=80°C



Speed=160mm/sec,T_{mold}=140°C



Speed=160mm/sec,T_{mold}=80 °C Injection speed

100µm Cavities Filling Process under Various Operating Parameters

Cavity thickness 100μm , Runner thickness 700μm



Speed=80mm/sec, T_{mold}=140°C



Speed=80mm/sec, T_{mold}=80°C



Speed=160mm/sec,T_{mold}=140°C



Speed=160mm/sec,T_{mold}=80 Injection speed

Conclusion

1. The flow hesitation will occur in near-end cavity when the cavity thickness is extremely thin compared to the runner dimensions.

- 2. The pressure arising speed of near-end cavity is slow when the melt is flowing in the runner leading to the far-end cavities. Consequently, this causes the melt temperature which in the near-end cavities are rapidly cooled down.
- 3. The decrease of melt temperature and flow speed causes the increase of melt viscosity which will result in the lag of the melt-front advancement.
- 4. Mold temperature is a critical processing parameter. High mold temperature can retard the effect of hesitation.

